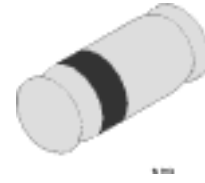




Switching Diode (FHLL4448)

Description

- The **FHLL4448** is designed for high-speed switching application in hybrid thick-and-thin-film circuits.
- Small surface mouting type.(**LL-34**)



ABSOLUTE MAXIMUM RATINGS 最大额定值($T_A=25$)

RATING	Symbol	Value	Unit
Reverse Voltage 反向电压	V_R	75	V
Repetitive peak reverse voltage 反向峰值电压	V_{RM}	100	V
Peak forward surge current 正向浪涌电流 (At $t_p=1 \mu s$)	I_{FSM}	2	A
Repetitive peak forward current 正向峰值电流	I_{FRM}	500	mA
Forward current 正向电流	I_F	300	mA
Average forward current 平均正向电流 (At $V_R=0$)	I_{FAV}	150	mA
Power Dissipation 耗散功率 at $T_A=25$	P_{TOT}	500	mW
Junction Temperature 结温	T_J	175	
Storage Temperature Range 存储温度	T_S	-65 to +175	

ELECTRICAL CHARACTERISTICS 电特性($T_A=25$)

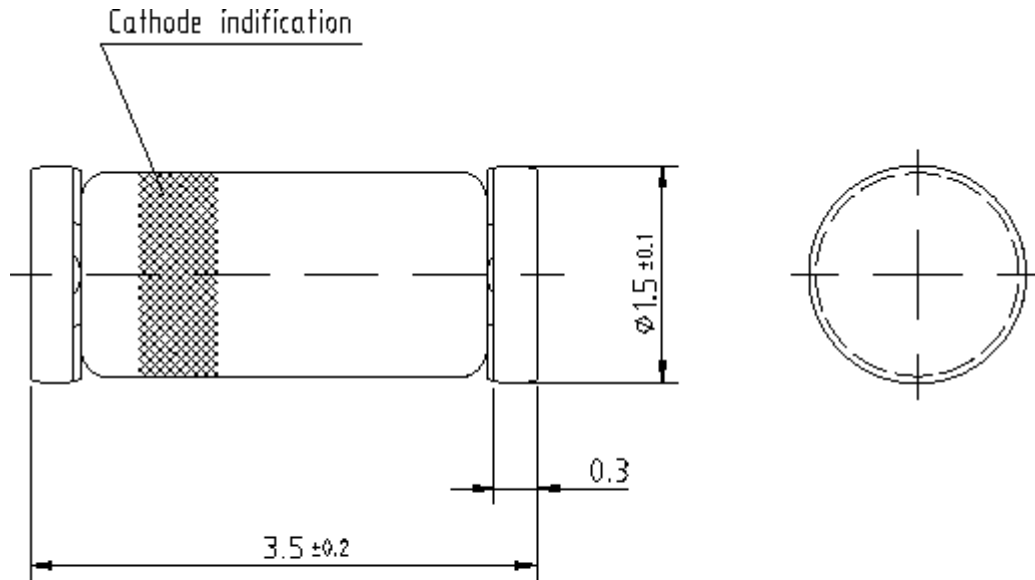
Characteristic 特性	Symbol	Min	Typ	Max	Unit
Forward Voltage 正向电压	V_F	0.62	-	0.72	V
At $I_F=5mA$		-	0.93	1.0	
Leakage current 漏电流	I_R	-	-	25	nA
At $V_R=20v$		-	-	5	μA
At $V_R=75v$		-	-	50	μA
At $V_R=20v, T_J=150$	I_R	-	-	50	μA
Reverse Breakage Voltage 反向击穿电压	$V_{(BR)R}$	100	-	-	V
$I_R=100 \mu A, t_p/T=0.01, t_p=0.3ms$					
Capacitance 电容	C_{tot}			4	pF
At $V_R=0, f=1.0MHz, V_{HF}=50mV$					
Reverse Recovery Time 反向回复时间	T_{rr}			8	ns
At $I_F=IR=10mA, i_R=1mA$				4	ns
At $I_F=10mA, V_R=6V, i_R=0.1 \times I_R, R_L=100$					
Junction tambient 热阻	R_{thJA}			500	K/W
on PC board 50mmx50mmx1.6mm					
Rectification Efficiency 整流功率	η_r	0.45			
at $f=100MHz, V_{HF}=2V,$					

Notes: (1)Valid provided that electrodes are kept at ambient temperature.



Dimensions 封装外形尺寸

Dimensions in mm



Glass case
Mini MELF / 50D 80
JEDEC DO 213 AA

961 2070


technical drawings
according to DIN
specifications